

Tentative Ver 0.10

TFT LCD Specification

Model NO.: TD035STED4

Customer Signature						
Date						

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Record of Reversion

Rev	Issued Date	Description
0.10	Apr, 13,2005	New



1. FEATURES

The 3.5" LCD module is the Transflective active matrix color TFT LCD module. LTPS (Low Temperature Poly Silicon) TFT technology is used and it's COG design. The LCD module includes touch panel, backlight and TFT LCD panel with minimal external circuits and components required.

2. GENERAL SPECIFICATION

Ito	em	Description	Unit
Display Size (Diagon	al)	3.5 inch (8.9cm)	-
Display Type		Transflective	-
Active Area (HxV)		53.28 X 71.04	mm
Number of Dots (HxV	()	240 x RGB x 320	dot
Dot Pitch (HxV)		0.074 X 0.222	mm
Color Arrangement		RGB Stripe	-
Color Numbers	mbers 262,144 (6 bits)		-
Outline Dimension (H	lxVxT)	64.3 X 87.1X4.1(Max 4.3)*	mm
Weight		TBD	g
LCD Panel +		25 (Typ)	
Power consumption	T-CON + L/S		mW
	Backlight	288 (Typ, I _F = 20mA)	

^{*} Exclude FPC and protrusions.

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3. INPUT/OUTPUT TERMINALS

3.1 TFT LCD module

Pin	Symbol	I/O	Description	Remark
1	DE	I	Data Enable Signal	
2	MCLK	I	LCM Pixel Clock	
3	RESET	I	Reset Signal	
4	YU	0	Upper electrode Y (Y+)	
5	DVSS	- 1	Digital Ground	
6	VCOM_I	I	VCOM Signal Input for LCD Panel	
7	VCOM_I	- 1	VCOM Signal Input for LCD Panel	
8	AVSS	- 1	Analog Ground	
9	VVEE	I	Input Voltage for gate off	
10	VVEE	- 1	Input Voltage for gate off	
11	VGH	I	Input Voltage for Level Shifter I/O	
12	VGH	- 1	Input Voltage for Level Shifter I/O	
13	DVSS	I	Digital Ground	
14	XL	0	Lower electrode X (X-)	
15	VCOM_H	0	Positive Power Output for VCOM	Connect big capacitor (10uF)
16	VCOM_O	0	VCOM Signal of IC Output	
17	VCOM_O	0	VCOM Signal of IC Output	
18	VCOM_L	0	Negative Power Output for VCOM	Connect big capacitor (10uF)
19	AVSS	I	Analog Ground	
20	DVDD	I	Digital Supply Power	
21	DVDD	I	Digital Supply Power	
22	AVDD	I	Analog Supply Power	
23	AVDD	I	Analog Supply Power	
24	YL	0	Lower electrode Y (Y-)	
25	DVSS	I	Digital Ground	
26	IV6P	0	for image sticking circuit	Negative voltage output for panel
27	XR	0	Upper electrode X (X+)	
28	TB_RL	I	Shift direction (Right/Left) H: D1→D240 L: D240→D1 Shift direction (Top/Bottom) H: Top→Bottom L: Bottom→Top	
29	R5	I	Data Bit Input (Red MSB)	
30	R4	I	Data Bit Input	

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31 R3 I Data Bit Input	
32 R2 I Data Bit Input	
33 R1 I Data Bit Input	
34 R0 I Data Bit Input (Red LSB)	
35 G5 I Data Bit Input (Green MSB)	
36 G4 I Data Bit Input	
37 G3 I Data Bit Input	
38 G2 I Data Bit Input	
39 G1 I Data Bit Input	
40 G0 I Data Bit Input (Green LSB)	
41 B5 I Data Bit Input (Blue MSB)	
42 B4 I Data Bit Input	
43 B3 I Data Bit Input	
44 B2 I Data Bit Input	
45 B1 I Data Bit Input	
46 B0 I Data Bit Input (Blue LSB)	
Connect big c	capacitor
47 ISC O for image sticking circuit (4.7uF or mor	re)
Digital Ground	
48 SCL I (Serial interface clock input)	
49 SDA I Digital Ground	
49 SDA I (Serial interface data input/output)	
50 CS I Digital Ground	
(Serial interface chip select input)	
51 DVSS I Digital Ground	
52 HSYNC I Horizontal SYNC Input	
53 DVSS I Digital Ground	
CM=L:	
54 CM I Display mode select	node (65k/262k color)
CM=H:	
Partial display	y mode (8 color)
Positive Power Output for Source	
Positive Power Output for Source O Driver	
55 VS	
55 VS O Driver	

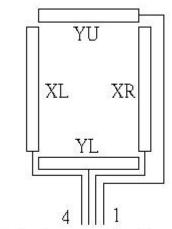
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59	LED-	0	LED Power (Cathode)	
60	LED-	0	LED Power (Cathode)	
61	DVSS	I	Digital Ground	

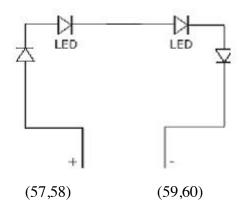
3.2 Touch panel Pin

Touch Panel	Module	Symbol	Description	Remark
Pin	Pin			
1	4	YU	Touch Panel Upper Side	
2	27	XR	Touch Panel Right Side	
3	24	YL	Touch Panel Lower Side	
4	14	XL	Touch Panel Left Side	



Pin Assignment for Touch panel

3.3 Back light pin assignment



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4. ABSOLUTE MAXIMUM RATINGS

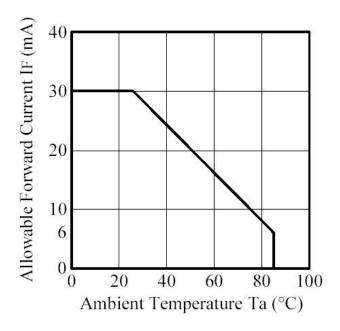
GND=0V

Item	Symbol	MIN	MAX	Unit	Remark
Lagia Supply Valtaga	DVDD	-0.3	+3.6	V	
Logic Supply Voltage	AVDD	-0.3	6	V	
Dower Supply for UN/ Driver	VGH	-0.3	+19	V	
Power Supply for H/V Driver	VVEE	-5.8	-5.2	V	Note 1
Touch Panel Operation Voltage	V_{Touch}	-	5.5	V	
Backlight LED forward Voltage	V_{F}	-	4	V	
Backlight LED reverse Voltage	V_R	-	5	V	
Backlight LED forward current (Ta=25°C)	l _F	-	30	mA	Note2
Operating Temperature	Topr	-10	+60	°C	
Storage Temperature	Tstg	-20	+70	°C	

Note1. The operating voltage is between +0.5V and -5.0V at the moment when the power is turned on

Note 2. Relation between maximum LED forward current and ambient temperature is showed as bellow.

Ambient Temperature vs. Allowable Forward Current



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5. ELECTRICAL CHARACTERISTICS

5.1 Driving TFT LCD Panel

T a=25°C

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Lacia Cumphy Valtage		DVDD	2.4	2.8	3.3	٧	
Logic Supply Voltage	5	AVDD	4.8	5	5.6	>	
Power Supply for H/	V Drivor	VGH	9.5	10	10.5	V	
Fower Supply for Til	v Diivei	VVEE	-5.8	-5.5	-5.2	>	
Logio Input Voltago	High	VIH	0.8DVDD	1	DVDD+0.3		R[5:0], G[5:0],
Logic Input Voltage	Low	VIL	DVSS	1	0.2DVDD	٧	B[5:0], CLK DE
Leakage curre	ent	L	-1	1	1	uA	
DVDD Supply Curre	ent	I _{DVDD}	-	0.74	1.9	mA	Note 1,2
AVDD Supply Current		I_{AVDD}	-	1.65	4.0	mA	Note 3
VGH Supply Current		I_{VGH}	-	0.07	0.2	mA	
VVEE Supply Curre	nt	I_{VVEE}	-	0.05	0.5	mA	

Note 1: The typical supply current specification is measured at the line inversion test pattern (black and white interlacing horizontal lines as the diagram shown below)



Note 2: DVDD rush current accept 120mA, 500u sec during system booting.

Note 3: Gamma correction voltage is set to achieve the optimum at AVDD=5.0V. Use the voltage at level as close to 5.0V as possible.

5.2 DC/DC Spec

the end of									
Item	Input voltage		Input Current	Input ripple(Max)					
	MIN	TYP	MAX						
DVDD	2.4V	2.8V	3.3V	0.74	1				
AVDD	4.8V	5V	5.6V	1.65	50 mV	Note 1			
VGH	9.5V	10V	10.5V	0.07	150mV				
WEE	-5.8 V	-5.5 V	-5.2 V	0.05					

Note 1: AVDD is analog voltage supply therefore use as less ripple as possible.

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5.3 Driving backlight

Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	l _F	ı	20	30	mA	LED/Part
LED Life Time	-	1	10,000	-	Hr	I _F : 15mA
Forward Current Voltage	V_{F}	1	3.6	4.0	V	I _F : 20mA ,LED/Part

Note: Backlight driving circuit is recommend as the fix current circuit.

5.4 Driving touch panel (Analog resistance type)

Ta=25°C

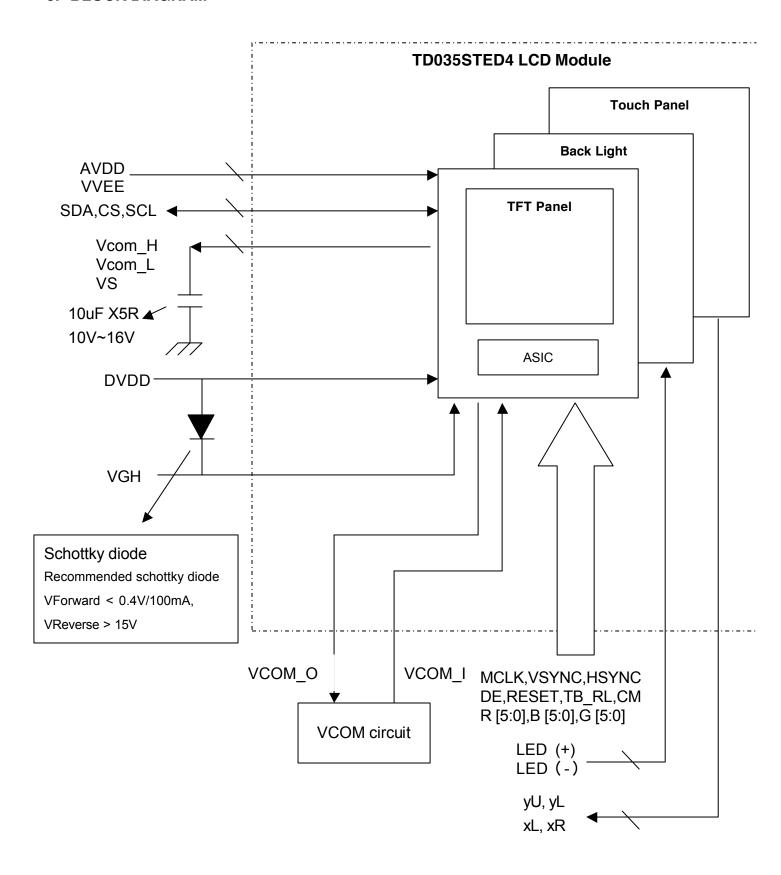
Item	Symbol	MIN	TYP	MAX	Unit	Remark
Resistor between terminals (XR-XL)	Rx	100	ı	1100	Ω	
Resistor between terminals (YU-YL)	Ry	100	ı	1100	Ω	
Operation Voltage	V_{Touch}	-	5	-	V	DC
Line Linearity (X direction)	-	- 1.5	ı	+1.5	%	Note 1
Line Linearity (Y direction)	-	- 1.5	ı	+1.5	%	Note 1
Chattering	-	ı	ı	10	ms	
Minimum tension for detecting	-	ı	80	-	g	
Insulation Resistance	Ri	20	-	_	МΩ	At DC 25V

Note 1. The minimum test force is 80 g.

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6. BLOCK DIAGRAM



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7. TIMING CHART

7.1 Display timing

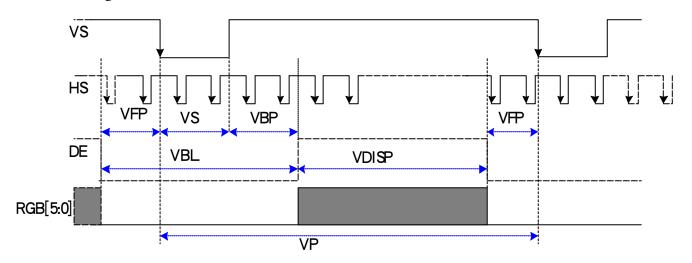
Display	Parameter	Symbol	Conditions	I	Unit			
Mode	Farameter	Symbol	Conditions	MIN	TYP	MAX		
	Vertical cycle	VP		323	326	340	Line	
	Vertical data start	VDS	VS+VBP	2	4	_	Line	
	Vertical front porch	VFP		1	2	_	Line	
	Vertical blanking period	VBL	VS+VBP+VFP	3	6	_	Line	
	Vertical active area	VDISP		_	320	_	Line	
Nicos	Horizontal cycle	HP		260	280	300	dot	
Normal	Horizontal front porch	HFP		4	10	_	dot	
	Horizontal Sync Pulse width	HS		8	10	_	dot	
	Horizontal Back porch	HBP		18	20	_	dot	
	Horizontal Data start	HDS	HS+HBP	26	30	_	dot	
	Horizontal active area	HDISP		240	240	240	dot	
	Clock froguency	tclk		4.5	5.44	7.0	MHz	
	Clock frequency	fclk			184		nS	

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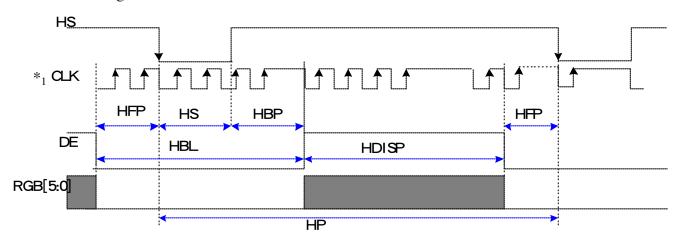


Input timing chart

< Vertical Timing chart>



< Horizontal Timing chart >



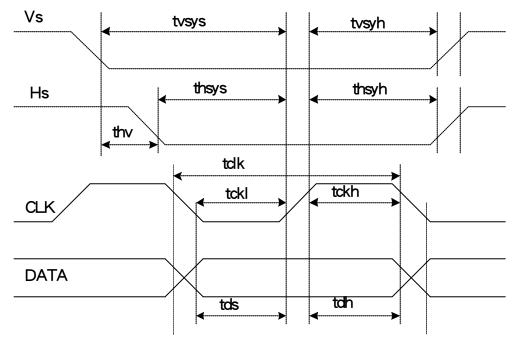
*_{1.} The frequency of CLK should be continued whether in display or blank region to ensure IC operating normally.

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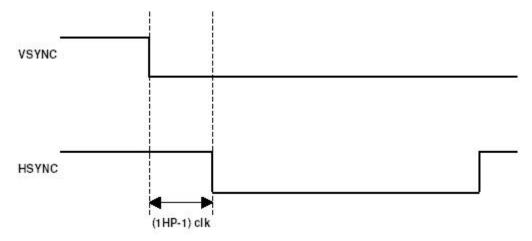


Setup/Hold Timing chart

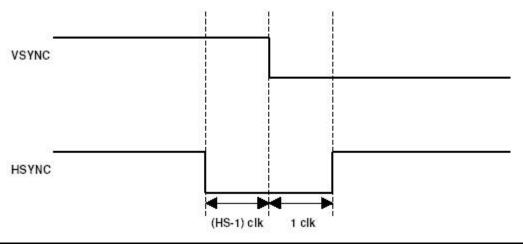


Phase difference of Sync.

Maximum Timing chart:



Minimum Timing chart:



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AC Characteristics:

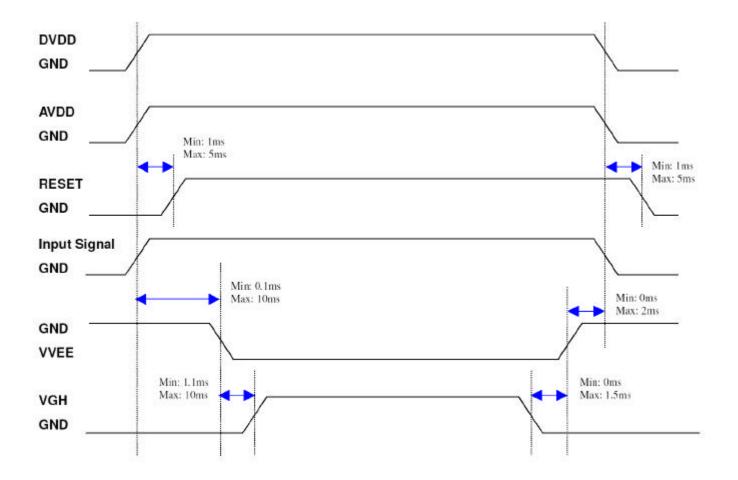
Parameter	Symbol	Conditions		Ratings		Unit	
Farameter	Symbol	Conditions	MIN	TYP	MAX	Orme	
Vertical Sync. Setup time	tvsys		20	1	_	ns	
Vertical Sync. Hold time	tvsyh		20	1	_	ns	
Horizontal Sync. Setup time	thsys		20	Ī	_	ns	
Horizontal Sync. Hold time	thsyh		20	ĺ	_	ns	
Phase difference of Sync. Signal Falling edge	thv		-(HS-1)	I	1HP-1	clk	
Clock "L" Period	tckl		30	50	70	%	
Clock "H" Period	tckh		30	50	70	%	
Data setup time	tds		20	1	_	ns	
Data Hold time	tdh		20	-	_	ns	
Digital logic input	Trise/Tfall				15	ns	

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8. Power On/Off Sequence



Power on sequence:

VDD1/2 & AVDD & Input signal → RESET → VVEE → VGH

Power off sequence:

VGH → VVEE → VDD1/2 & AVDD & Input signal → RESET

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9. Optical Characteristics

9.1 Optical Specification

(1) Back light Off w / Touch panel

Ta=25°C

Item	Symb	ool	Condition	MIN	TYP	MAX	Unit	Remarks	
	Θ1	1		45	50	ı			
Viewing Angles	Θ 1:	2	CR = 2	25	35	ı	Dograd	Note 9-1	
	Θ2	1	CR - 2	30	40	ı	Degree		
	Θ 2	2		45	55	ı			
Chromoticity	\\/bito	Х	Θ=0°	0.26	0.31	0.36	-	Note 0.2	
Chromaticity	White	у	D	0.30	0.35	0.40	-	Note 9-3	
Contrast Ratio	CR		Θ=0°	10:1	15:1	-	-	Note 9-2	
Reflectivity	R		Θ=0°	7	10	-	%	Note 9-4	

(2) Back Light On w / Touch panel

Ta=25°C

Item	Symbol	Condition	MIN	TYP	MAX	Unit	Remarks	
	Θ 11		50	60	1			
Viewing Angles	Θ 12	CR = 2	50	60	1	Degree	Note 9-1	
Viewii ig Ai igies	Θ 21	UN - 2	40	50	ı	Degree	NOIG 9-1	
	Θ 22		50	60	1			
Response Time	Tr+Tf	Θ=0°	-	35	45	ms	Note 9-5	
Contrast Ratio	CR	Θ=0°	80:1	100:1	-	-	Note 9-6	
Luminance	L	Θ =0° I _F =20mA	TBD	115	ı	cd/m ²	Note 9-7	
NTSC	-	-	32	36	-	%	Note 9-7	
Uniformity	-	-	70	80	-	%	Note 9-8	
Chromoticity	White	Θ=0°	0.26	0.31	0.36		Note 9-3	
Chromaticity	y	_	0.28	0.33	0.38	_	NOIE 9-3	

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9.2 .Basic measure condition

(1) Driving voltage

VDD= 12.0V, VEE=-6.5V

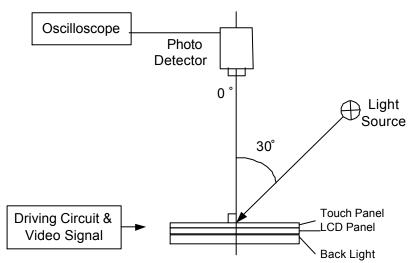
(2) Ambient temperature: Ta=25°C

(3) Testing point: measure in the display center point and the test angle $\Theta = 0^{\circ}$

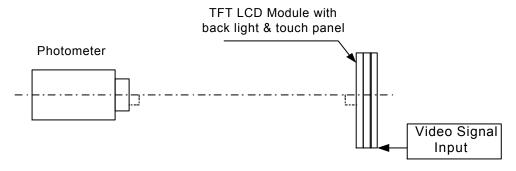
(4) Testing Facility

Environmental illumination: = 1 Lux

a. System A



b. System B

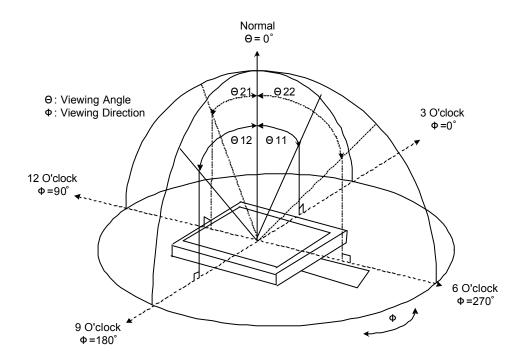


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Note 9-1: Viewing angle diagrams (Measure System A)



Note 9-2: Contrast ratio in back light off (Measure System A)

Contrast Ration is measured in optimum common electrode voltage.

$$CR = \frac{Luminance with white image}{Luminance with black image}$$

Note 9-3: White chromaticity as back light off: (Measure System A)

Note 9-4: Reflectivity (R) (Measure System A)

In the measuring system A,.calculate the reflectance by the following formula.

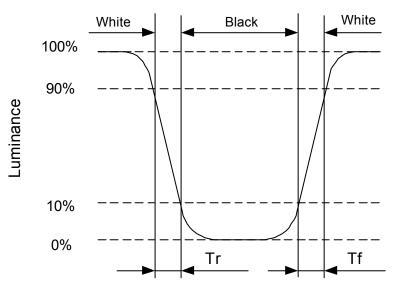
Reflectivity(R)=
$$\frac{\text{Output from the white display panel}}{\text{Output from the reflectance standard}} \times \begin{cases} \text{Reflectance factor of reflectance} \\ \text{standard} \end{cases}$$

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Note 9-5: Definition of response time: (Measure System B)



Note 9-6: Contrast Ratio in back light On (Measure System B)

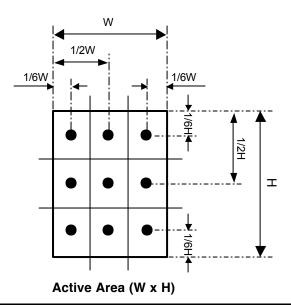
Contrast Ration is measured in optimum common electrode voltage.

Note 9-7: Luminance: (Measure System B)

Test Point: Display Center

Note 9-8: Uniformity (Measure System B)

The luminance of 9 points as the black dot in the figure shown below are measured and the uniformity is defined as the formula:



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10. Reliability

No	Test Item	Condition				
1	High Temperature Operation	Ta=+60°C, RH < 40%, 240hrs				
2	High Temperature & High Humidity Operation	Ta=+40°C, 95% RH, 240hrs				
3	Low Temperature Operation	Ta= -10°C, 240hrs				
4	High Temperature Storage (non-operation)	Ta=+70°C, 240hrs				
5	Low Temperature Storage (non-operation)	Ta= -20°C, 240hrs				
6	Thermal Shock (non-operation)	-20°C(30 min)← → 70°C(30 min),30 cycles				
	Conform Discharge (non-constitut) (LCD	C=150pF, R=330 Ω;				
7	Surface Discharge (non-operation) (LCD	Discharge: Air: ±15kV; Contact: ±8kV				
	surface)	5 times / Point; 5 Points / Panel				
8	Shock (non eneration)	Acceleration: 100G; Period: 6ms				
°	Shock (non-operation)	Directions: ±X, ±Y, ±Z; Cycles: Three times				
		Hit 1,000,000 times with a silicon rubber of				
9	Pin Activation Test (Touch Panel)	R0.8, HS 60.				
9		Hitting Force: 250g				
		Hitting Speed: 3 time/sec				
		Pen: 0.8R Polyacetal stylus				
	Writing Friction Resistance Test (Touch	Load: 250g				
10	Panel)	Speed: 3 Strokes/sec				
	anci)	Stroke: 35mm				
		100000 times				

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11. Handling Cautions

11.1 ESD (Electrical Static Discharge) strategy

ESD will cause serious damage of the panel, ESD strategy is very important in handling. Following items are the recommended ESD strategy

- (1) In handling LCD panel, please wear gloves with non-charged material. Using the conduction ring connect wrist to the earth and the conducting shoes to the earth is necessary.
- (2) The machine and working table for the panel should have ESD protection strategy.
- (3) In handling the panel, ionized air flowing decrease the charge in the environment is necessary.
- (4) In the process of assemble the module, shield case should connect to the ground.

11.2 Environment

- (1) Working environment should be clean room.
- (2) Because touch panel has protective film on the surface, please remove the protection film slowly with ionizer to prevent the electrostatic discharge.

11.3 Touch panel

- (1) The front touch panel is vulnerable to heavy weight, so any input must be done by special stylus or by a finger. Do not put any heavy stuff on it.
- (2) When any dust or stain is observed on a film surface, clean it using a lens cleaner for glasses or something similar.

11.4 Others

- (1) Turn off the power supply before connecting and disconnecting signal input cable.
- (2) Because the connection area of FPC and panel is not so strong, do not handle panel only by FPC or bend FPC.
- (3) Water drop on the surface when panel is powered on will corrode panel electrode.
- (4) Before opening up the packing bag, watch out the environment for the panel storage. High temperature and high humidity environment is prohibited.
- (5) In the case the TFT LCD module is broken, please watch out whether liquid crystal leaks out or not. If your hand touches liquid crystal, wash your hands cleanly with water and soap as soon as possible

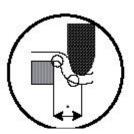
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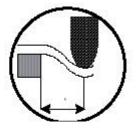


12. Application Note

- 12.1 Design notes on touch panel
 - (1) Explanation of each boundary of touch panel
 - A. Boundary of Double-sided adhesive
 - a. Electrically detectable within this zone.When holding the touch panel by housing, it needs to be held at outside of this zone.
 - b. Film is supported by double-sided adhesive tape.
 - B. Viewing area
 - a. Cosmetic inspection to be done for this area.
 This area is set as inside of boundary of double-sided adhesive with tolerance.
 - C. Boundary of transparent insulation
 - a. Purpose is to "Help" to secure insulation.
 - b. Electrical insulation on this area is not guaranteed.
 - c. We do recommend not to hold this area by something like housing or gasket.
 - D. Active area
 - a. This area is where the performance is guaranteed.
 This area set as some distance inside from the boundary area of double-sided adhesive tape since its neighboring area is less durable to writing friction.
 - b. Please refer to the attached module drawing for the bezel opening and window size design.

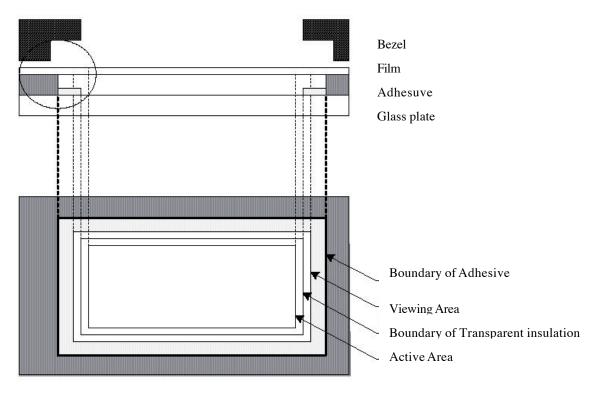


There is some possibility to damage ITO



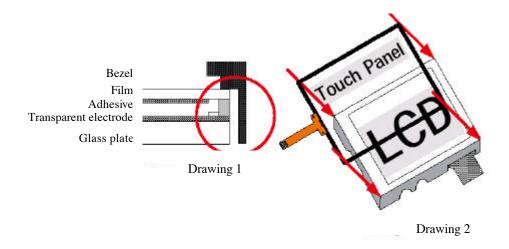
No Damage to ITO





(2) Housing and touch panel

- a. Please have clearance between the side of touch panel, and any conductive material such as metal frame.(drawing.1) Transparent electrode exists on glass of touch panel from end to end.
- b. It is recommended to fix a touch panel on the LCD module chassis rather than the touch panel housing. Clinging at conductive material and side of touch panel might cause malfunction.



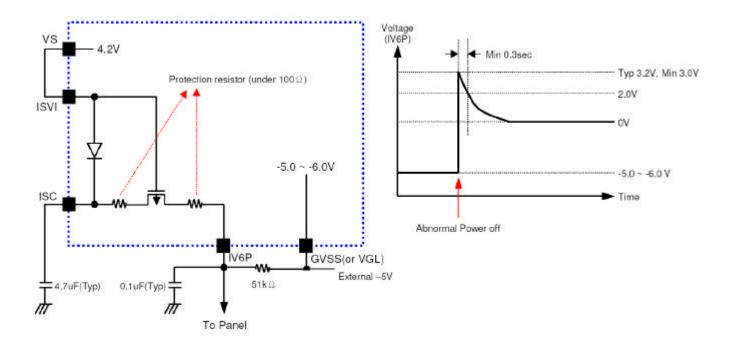
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12.2 Note for image discharge circuit

- (1) The image will remain on display when the power is suddenly cut off in abnormal condition, ie, unit dropped and battery fell out. The phenomenon is because the electrical charge well be held in pixel, if there is no extra input signal to release it, the residual image occurs.
- (2) The imaging discharge circuit is used for clearing the image residual on display. The circuit is designed on panel IC and customer can input signal to driver the function especially in the case that the battery or power supplier unit are removable.
- (3) The circuit below is designed on panel IC to avoid image sticking.

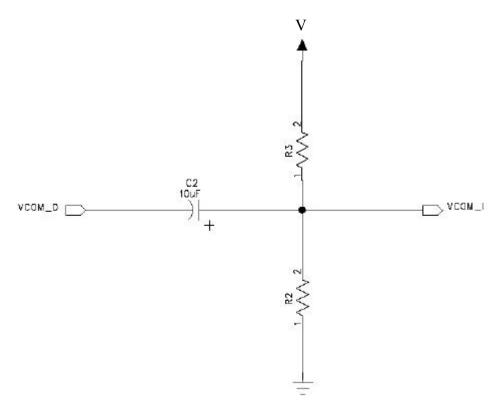


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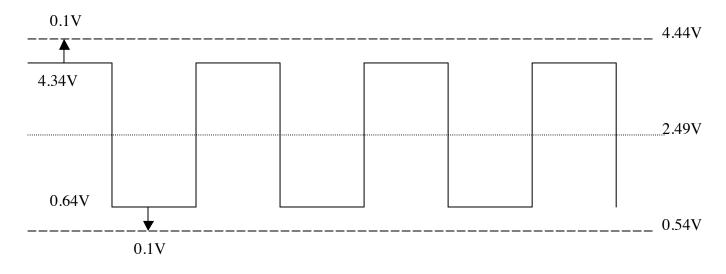


12.3 Note for V-com circuit

The circuit is designed for V-com fine-tune, please refer the circuit below to design application circuit.



Vcom waveform



Note: V:5V

R2: 10~20 K Ohm R3: 10~20 K Ohm

Resistors tolerance : 0.5~1 %

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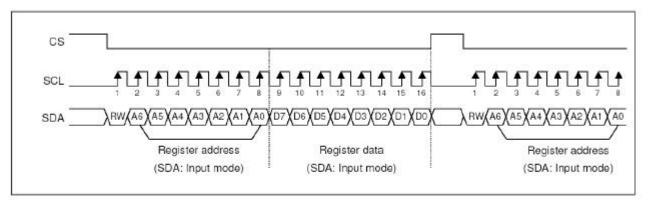


12.4 Note for SPI command

The LCM support the 3-pin serial interface to set internal register. Read/Write bit RW, Serial address A6 to A0 and serial data D7 to D0 are read at the rising edge of the serial clock, via the serial input pin. This data is synchronized on the rising edge of eighth serial clock and is then converted to parallel data. The serial interface signal timing chart is shown below.

Serial Interface Signal Timing Chart

Write Mode (RW=L)



The shift register and counter are reset to their initial values when the chip select signal is inactive. Do not set the chip select signal to inactive between transmission of an 8-bit address and 8-bit data set for the command.

When using SCL wiring, the module has to be designed carefully to avoid any noise coming from reflection or from external sources. We recommand checking operation with the actual module.

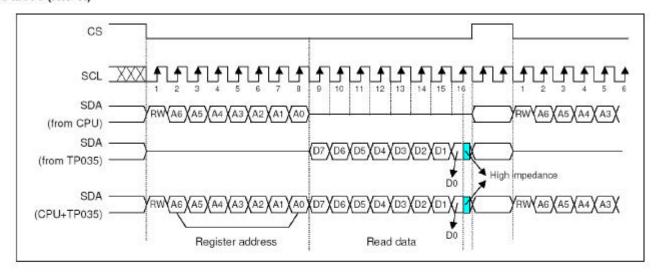
If there is a break in data transmission by RESETB or CS pulse, while transferring a Command or Parameter, before Bit D0 of the byte has been completed, then LCM will reject the previous bits and have reset the interface such that it will be ready to receive the same byte re-transmitted when the chip select line (CS) is activated after RESETB have been High state.

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Read Mode (RW=H)



The read mode of the interface means that the micro controller reads data from the LCM.

To do so the micro controller first has to send a command: the read status command.

Then the following byte is transmitted in the opposite direction. After that CS is required to go high.

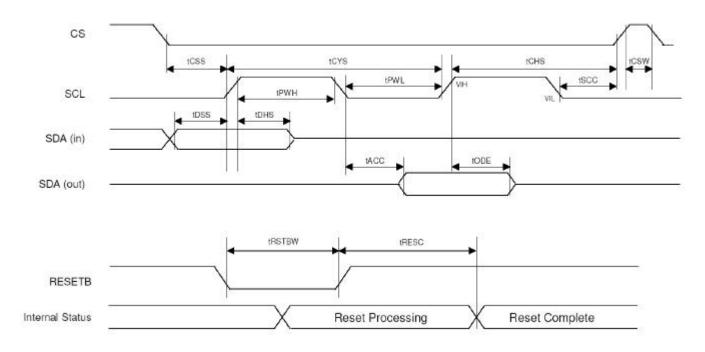
The LCM samples the SDA data input at rising SCL edges, but shifts SDA data output at falling SCL edges. Thus the micro controller is supposed to read SDA data at rising SCL edges.

After the read status command has been sent, the SDA line must be set to tristate not later then at the rising SCL edge of the last bit.

The LCM can read data of the Register0 to Register63



Serial interface and Reset waveform (VIH=0.8VDD1, VIL=0.2VDD1)



Serial interface and Reset						
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Clock cycle	tCYS	-	150	-	-	ns
Clock High Period	tPWH	-	60	-	-	ns
Clock Low Period	tPWL	-	60	-	-	ns
Data Set-up Time	tDSS	-	60	-	-	ns
Data Hold Time	tDHS	-	60	-	-	ns
CS High width	tCSW	-	1	-	-	us
CS Set-up Time	tCSS	-	60	-	-	ns
CS Hold Time	tCHS	-	70	-	-	ns
SCL to CS	tSCC		40	-	-	ns
Output Access Time	tACC		10	-	50	ns
Output Disable Time	tODE		25	-	80	ns
RSTB low width	tRSTBW	-	1000	-	-	ns
RESET complete time	tRESC	-	-	-	1000	ns

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Command descriptions :

Reset the internal register by setting low level the RESETB pin or software reset command.

Register Default Bit name		Bit name	Setting value [D7 D6 D5 D4 D3 D2 D1 D0								Description	Remark
[Dec]	[Hex]		D7	D6					D1	D0		
R0	00h	CHIPID[2:0]	t			t					Chip ID (Read only)	The Chip ID can be changed by
110	0011	Or in iD[2.0]			0	0	0				ID 0(LDS312A)	MASK Option.
				1	0	0	1				ID 1(LDS312B)	
				1	-	-	-				ID I(LD331ZB)	
				-							- ID 0	
				1	1	1	0				ID 6	
			_	_	1	1	1				ID 7	
		REVID[2:0]									Revision ID (Read only)	The Revision ID can be changed
								0	0	0	REV 0	by MASK Option.
								0	0	1	REV 1	
						<u> </u>		-	-	-	-	
								1	0	1		
								1	1	0	REV 6	
								1	1	1	REV 7	
R1	68h	VCM8[7:5]									VCOM amplitude adjustment by VCOMH voltage change	VCOMH voltage change
			0	0	0						-0.3V	
			0	0		H					-0.2V	
			0	1	_						-0.1V	
			_	1	1						0.0V	
			0			₩	-	-	_	<u> </u>		
			1	0	0	<u> </u>	-	-	_	_	0.1V	 -
			1	0	1	₩	_			<u> </u>	0.2V	— ∥
			1	1	0						0.3V	
			1	1	1						0.4V	1
		VCM8[3:0]		1							VCOM voltage select	VCOM_DC value setting
		V Olvio[o.o]		1			0	0	0	0	VCOMH=3.90V; VCOML=0.20V	V COINI_BO value setting
				1				_	_	_		
			-	1	1	-	0	0	0	1	VCOMH=3.92V; VCOML=0.22V	
			_	_		<u> </u>	0	0	1	0	·	
							0	0	1	1	VCOMH=3.96V; VCOML=0.26V	
							0	1	0	0	VCOMH=3.98V; VCOML=0.28V	
							0	1	0	1	VCOMH=4.00V; VCOML=0.30V	
							0	1	1	0	VCOMH=4.02V; VCOML=0.32V	
							0	1	1	1	VCOMH=4.04V; VCOML=0.34V	
						İ	1	0	0	_	VCOMH=4.06V; VCOML=0.36V	
							1	0	0	1	VCOMH=4.08V; VCOML=0.38V	
			_	-		<u> </u>	1	0	1	0		
			_	1	1	1				_		
			-	1	1	-	1	0	1	1	VCOMH=4.12V; VCOML=0.42V	
							1	1	0	0	VCOMH=4.14V; VCOML=0.44V	
							1	1	0	1	VCOMH=4.16V; VCOML=0.46V	
							1	1	1	0	VCOMH=4.18V; VCOML=0.48V	
							1	1	1	1	VCOMH=4.20V; VCOML=0.50V	
R2	00h	MSEL										Mode slection
											Interface mode select	
				_	1	<u> </u>						
			0								VSYNC + HSYNC + DE mode	
			_								V31NC+1131NC+DE1110de	
			L	1	1	1				l		
			1	1	1	1				l	VSYNC + HSYNC mode	
		CVALOR	1		1	t					CVNC malarity calcut	
		SYNCP	—		_	\vdash	-	-	_	<u> </u>	SYNC polarity select	— I
			\vdash	1	0	-	-		—	-	Negative	
			L	<u> </u>	1	<u>L</u>				L	Positive	
		DINT									Input data mapping select	
						0					18 bit interface (262k color)	
				t	1	1					16 bit interface (65k color, R:G:B=5:6:5)	
		DCKP	1		1	Ė					Input clock polarity change	
		2010	\vdash	1	T	t	0				No change	
			\vdash	1—	₩	┢	_	-	├	-	·	
		ļ	1	1	_	₩	1	-	_	<u> </u>	Change	
R3	04h	VSTS[3:0]	L	L	<u> </u>				Ц_		Vertical valid data start time select (VBP)	Default:
							0	0	0	0	2 HSYNC	QVGA = 4 HSYNC
					1		0	0	0	1	2 HSYNC	QCIF+ = 7 HSYNC
				1	1	t	0	0	1	_	2 HSYNC	128x160 = 13 HSYNC
				1	1	t	0	0	1		3 HSYNC	240x240 = 4 HSYNC
			\vdash	╁	+-	H	_		_	_		—
			\vdash	₩	+	₩	0	1	0		4 HSYNC	
			\vdash	1	1—	<u> </u>	0	1	0	1	5 HSYNC	 -
I					1	1	-	-	-	-	I =	_
			_	_	_			_		_	15 HSYNC	

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Dead 1	D-4 "	Dit .	1		_	- 44"					Description	II Daniela de la constanta de	
Register [Dec]	Default [Hex]	Bit name	P-7	l De		etting			D1	DО	Description	Remark	
		HOTOGO	ן טו	D6	D5	υ4	צע	צען	וען	טט	Linda and the standing	Deferrit	
R4	1Dh	HSTS[5:0]	-	-	0	0	0	0	0	0	Horizontal valid data start time select (HBP) 10 DCK	Default: QVGA = 30 DCK	
			H		0	0	0	0	0	1	10 DCK	QCIF+ = 44 DCK	
					0	0	0	0	1	0	10 DCK	128x160 = 36 DCK	
				Ħ	0	0	0		1	1	10 DCK	240x240 = 30 DCK	
					0	0	0	1	0	0	10 DCK		
					0	0	0	1	0	1	10 DCK		
					0	0	0	1	1	0	10 DCK		
			<u> </u>		0	0	0	1	1	1	10 DCK	_	
			_	_	0	0	1	0	0	0	10 DCK	_	
				\vdash	0	0	1	0	0	1	10 DCK	4	
				+	0	0	1	0	1	0	10 DCK 11 DCK	-	
			┢	\vdash	0	0	1	1	0	0	12 DCK	-	
			H		-	-	-	 	-	-	- IZ DCK		
					0	1	1	1	1	0	30 DCK	1	
					-	-	·	Ė	Ė	·	-	1	
					1	1	1	1	1	1	63 DCK		
R5	01h	PARS[7:0]									Partial start line select	When VSYNC+HSYNC+DE	
		' '	0	0	0	0	0	0	0	0	Do not setting when PARS[8]=0, Gate256 is selected when PARS[8]=1	mode,	
			0	0	0	0	0	0	0	1	Gate1 is selected when PARS[8]=0, Gate257 is selected when PARS[8]=1	DE=H: Normal display line	
			0	0	0	0	0	0	1	0	Gate2 is selected when PARS[8]=0, Gate258 is selected when PARS[8]=1	DE=L: Non-display line (White)	
			0	0	0	0	0	0	1	1	Gate3 is selected when PARS[8]=0, Gate259 is selected when PARS[8]=1	M/han VCVAIC II IOVAIC di	
			Ŀ	Ŀ	<u> </u>	-	1		-	-	-	When VSYNC+HSYNC mode, Normal display line can be	
			0	0	1	1	1	1	1	1	Gate63 is selected when PARS[8]=0, Gate319 is selected when PARS[8]=1	selected by R5,6,7 and 8.	
			0	1	0	0	0		0	0	Gate64 is selected when PARS[8]=0, Gate320 is selected when PARS[8]=1	beleeted by 1 to,o,7 and o.	
			0	1	0	0	0	0	0	1	Gate65 is selected when PARS[8]=0, Do not setting when PARS[8]=1	4	
			0	1	0	0	0	0	1	0	Gate66 is selected when PARS[8]=0, Do not setting when PARS[8]=1	_	
			-	-	-	-	-	-	-	-	-		
			1	1	1	1	1	1	1	1	Gate127 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			1	0	0	0	0	0	0	0	Gate128 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			1	0	0	0	0	0	0	1	Gate129 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			1	0	0	0	0	0	1	0	Gate130 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			-	-	-	-	-	-	-	-	-		
			1	1	1	1	1	1	0	0	Gate252 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			1	1	1	1	1	1	0	1	Gate253 is selected when PARS[8]=0, Do not setting when PARS[8]=1		
			1	1	1	1	1	1	1	0	Gate254 is selected when PARS[8]=0, Do not setting when PARS[8]=1	_	
			1	1	1	1	1	1	1	1	Gate255 is selected when PARS[8]=0, Do not setting when PARS[8]=1	4	
R6	00h	PARS[8]	<u> </u>	1	1						Partial start line select		
			<u> </u>	-	+					0	Gate1 – Gate255 is selected	4	
	001	DADETO	┢	┢	₩					1	Gate256 – Gate320 is selected	W. VOVALO HOVALO DE	
R7	20h	PARE[7:0]	Ļ	Ļ.	Ļ		Ļ	Ļ	Ļ	Ļ	Partial end line select	When VSYNC+HSYNC+DE mode.	
			0	_	0	0	0	0	0	0	Do not setting when PARE[8]=0, Gate256 is selected when PARE[8]=1	DE=H: Normal display line	
			0	0	0	0	0	0	0	0	Gate1 is selected when PARE[8]=0, Gate257 is selected when PARE[8]=1 Gate2 is selected when PARE[8]=0, Gate258 is selected when PARE[8]=1	DE=L: Non-display line (White)	
			0	0	0	0	0		1	1	Gate3 is selected when PARE[8]=0, Gate259 is selected when PARE[8]=1	┨	
			-	-	-	-	<u> </u>	-	Ė	<u> </u>	Sales is selected when the religion, Sales 200 is selected when the religion	When VSYNC+HSYNC mode,	
			0	0	0	1	1	1	1	1	Gate31 is selected when PARE[8]=0, Gate286 is selected when PARE[8]=1	Normal display line can be	
			0	0	1	0	0	0	0	0	Gate32 is selected when PARE[8]=0, Gate287 is selected when PARE[8]=1	selected by R5,6,7 and 8.	
				0	_	0	0		0	1	Gate33 is selected when PARE[8]=0, Gate288 is selected when PARE[8]=1]	
			0	0	1	0	0	0	1	0	Gate34 is selected when PARE[8]=0, Gate289 is selected when PARE[8]=1		
			-	-	-	-	-	-	-	-	-	1	
			1	0	1	1	1	1	1	0	Gate63 is selected when PARE[8]=0, Do not setting when PARE[8]=1]	
			1	0	1	1	1	1	1	1	Gate64 is selected when PARE[8]=0, Do not setting when PARE[8]=1]	
			1	1	0	0	0		0	0	Gate65 is selected when PARE[8]=0, Do not setting when PARE[8]=1	<u> </u>	
			1	1	0	0	0	0	0	1	Gate66 is selected when PARE[8]=0, Do not setting when PARE[8]=1	_	
			Ŀ	1-	 -	-	<u> </u>	-	-	-	-	4	
			1	1	1	1	1	1	0	0	Gate252 is selected when PARE[8]=0, Do not setting when PARE[8]=1	4	
			1	1	1	1	1	1	0	1	Gate253 is selected when PARE[8]=0, Do not setting when PARE[8]=1	4	
			1	_	1	1	1	1	1	1	Gate254 is selected when PARE[8]=0, Do not setting when PARE[8]=1	-	
R8	00h	PARE[8]	H	۲	۲	-	H	H	H	_	Gate255 is selected when PARE[8]=0, Do not setting when PARE[8]=1 Partial end line select	1	
KΟ	OUL	FARE[0]	\vdash	╀	╀		-	_	_	^	Gate1 – Gate255 is selected		
			—	╁	╁		<u> </u>	 	 	1	Gate 1 – Gate 255 is selected Gate 256 – Gate 320 is selected	1	
		1	_	1	_	_	_	Ь—	Ь—	<u> </u>	Odio200 Odio020 io obiodiod	11	

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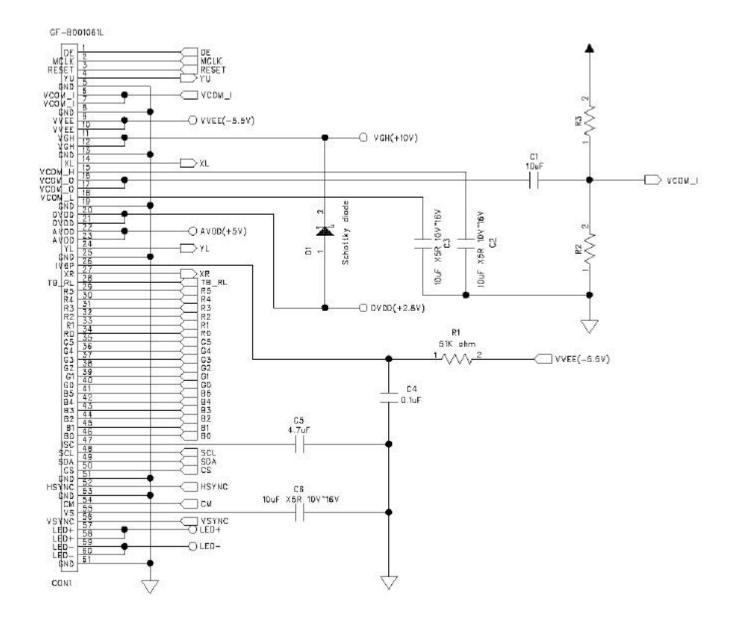
Register	Default	Bit name		Setting value							Description	Remark
[Dec]	[Hex]		D7	D6	D5	D4	D3	D2	D1	D0		
R10	00h	CMDR									Software reset	
										0	Normal	1
										1	Software reset	
R11	67h	VCM8[7:5]									VCOM amplitude adjustment by VCOMH voltage change	VCOMH voltage change
			0	0	0						-0.3V	(8 color partial mode)
			0	0	1						-0.2V]
			0	1	0						-0.1V	
			0	1	1						0.0V	
			1	0	0						0.1V	
			1	0	1						0.2V	1
			1	1	0						0.3V]
			1	1	1						0.4V	1

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12.5 Notes for FPC circuit layout

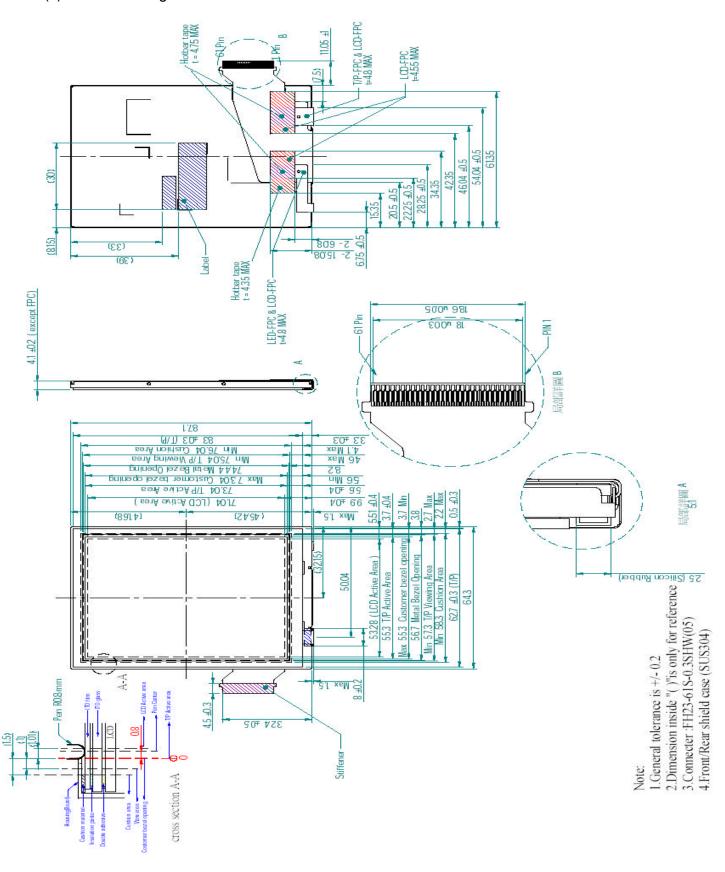


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13 Mechanical Drawing

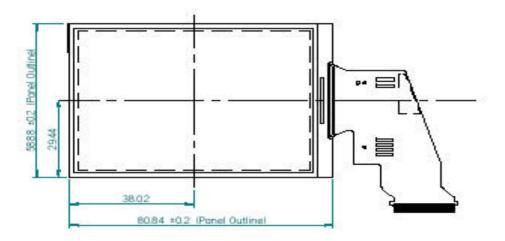
(1) Module drawing



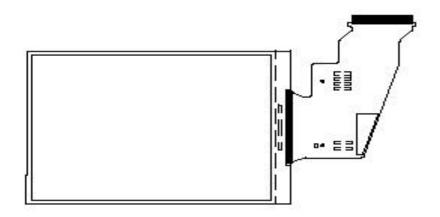
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(2) Cell panel + FPC drawing



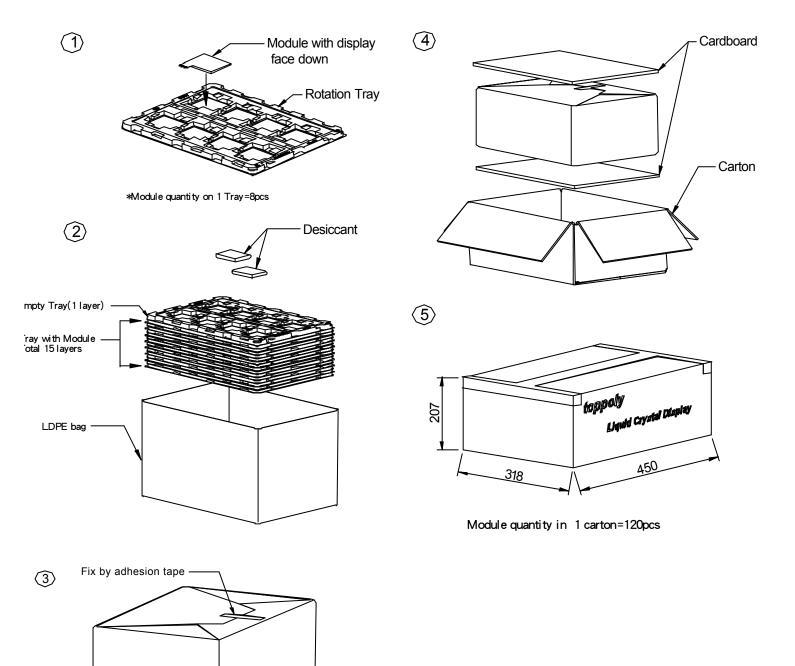




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14 Packing Drawing



TD035STED4 module delivery packing method

- (1). Module packed into tray cavity with display face down.
- (2). Tray stacking with 15 layers and with 1 empty tray above the stacking tray unit. 2 pcs desiccant put above the empty tray.
- (3). Stacking tray unit put into the LDPE bag and fix by adhesive tape.
- (4) Put 1pc cardboard inside the carton bottom, then pack the finished package into the carton.
- (5). Carton sealing with adhesive tape.

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